BCR3FM-12RB

600V - 3A - Triac

Medium Power Use

R07DS0962EJ0201
Rev.2.01
Feb. 19, 2019

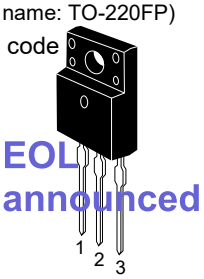
Features

- $I_{T\,(RMS)}$: 3 A
- V_{DRM}: 600 V
- Tj: 150 °C
- I_{FGTI}, I_{RGTI}, $I_{RGT\,III}$: 15 mA (10 mA) Note5
- Insulated Type
- Planar Passivation Type
- Viso: 2000 V

Outline

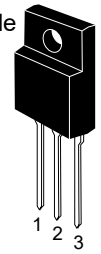
RENESAS Package code: PRSS0003AG-A
(Package name: TO-220FP)

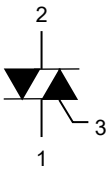
Ordering code
#BB0
#FA0



RENESAS Package code: PRSS0003AP-A
(Package name: TO-220FPA)

Ordering code
#BG0
#FG0





1. T_1 Terminal
2. T_2 Terminal
3. Gate Terminal

Application

Electric rice cooker, electric pot, and other general purpose resistive loads.

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		12	
Repetitive peak off-state voltage Note1	V_{DRM}	600	V
Non-repetitive peak off-state voltage Note1	V_{DSM}	720	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T\,(RMS)}$	3	A	Commercial frequency, sine full wave 360° conduction, Tc = 136°C (#BB0) Note2 Tc = 130°C (#BG0, #FG0, #FA0) Note2
Surge on-state current	I_{TSM}	30	A	60 Hz sinewave 1 full cycle, peak value, non-repetitive
I^2t for fusion	I^2t	3.7	A^2s	Value corresponding to 1 cycle of half wave 60 Hz, surge on-state current
Peak gate power dissipation	P_{GM}	3	W	
Average gate power dissipation	$P_{G\,(AV)}$	0.3	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I_{GM}	0.5	A	
Junction Temperature	Tj	–40 to +150	°C	
Storage temperature	Tstg	–40 to +150	°C	
Isolation voltage Note6	V_{iso}	2000	V	Ta=25°C, AC 1 minute, T_1 • T_2 • G terminal to case

Notes: 1. Gate open.
2. Please refer to the Ordering Information.

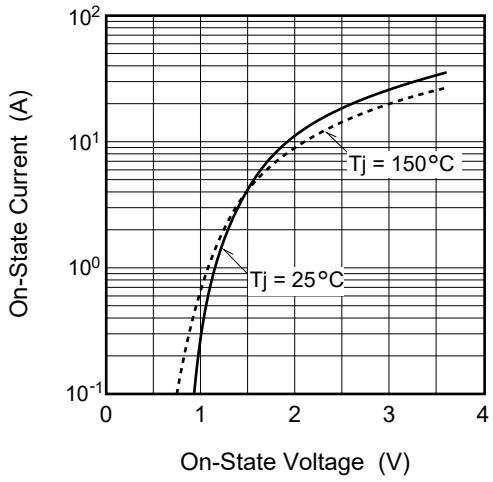
Electrical Characteristics

Parameter		Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current		I_{DRM}	—	—	2.0	mA	Tj = 150°C, V_{DRM} applied
On-state voltage		V_{TM}	—	—	1.5	V	Tc = 25°C, I_{TM} = 4.5A, instantaneous measurement
Gate trigger voltage[Note3]	I	V_{FGTI}	—	—	1.5	V	Tj = 25°C, V_D = 6 V, R_L = 6 Ω, R_G = 330 Ω
	II	V_{RGTI}	—	—	1.5	V	
	III	V_{RGTIII}	—	—	1.5	V	
Gate trigger curent[Note3]	I	I_{FGTI}	—	—	15 [Note5]	mA	Tj = 25°C, V_D = 6 V, R_L = 6 Ω, R_G = 330 Ω
	II	I_{RGTI}	—	—	15 [Note5]	mA	
	III	I_{RGTIII}	—	—	15 [Note5]	mA	
Gate non-trigger voltage		V_{GD}	0.2	—	—	V	Tj = 125°C, V_D = 1/2 V_{DRM}
			0.1	—	—		Tj = 150°C, V_D = 1/2 V_{DRM}
Thermal resistance		$R_{th\ (j-c)}$	—	—	4.0	°C/W	Junction to case[Note4] (#BB0)[Note2]
			—	—	5.2	°C/W	Junction to case[Note4] (#BG0, #FG0, #FA0)[Note2]

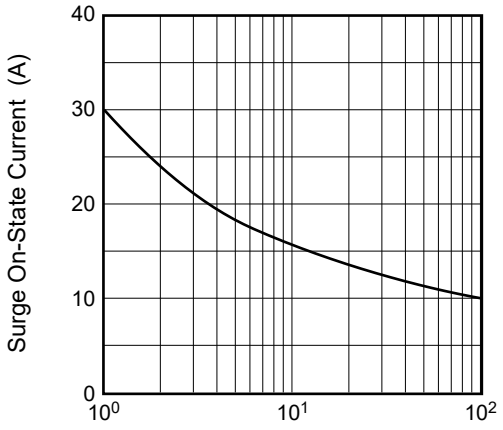
Notes: 3. Measurement using the gate trigger characteristics measurement circuit.
4. The contact thermal resistance $R_{th(c-f)}$ in case of greasing is 0.5°C /W.
5. High sensitivity (I_{GT}≤10mA) is also available. (I_{GT} item:1)
6. Make sure that your finished product containing this device meets your safe isolation requirements. For safety, it's advisable that heatsink is electrically floating.

Performance Curves

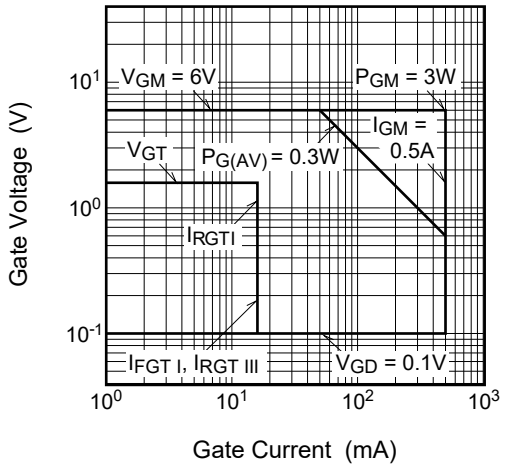
Maximum On-State Characteristics



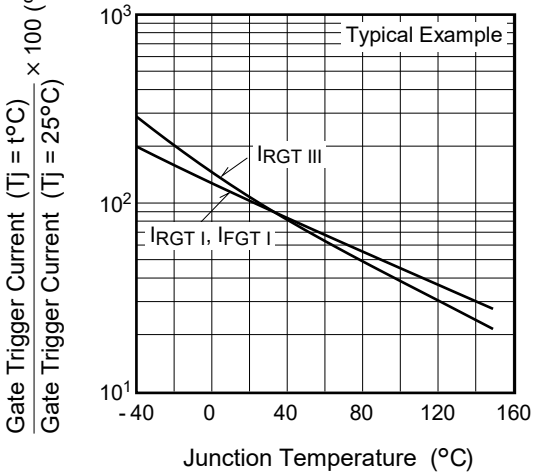
Rated Surge On-State Current



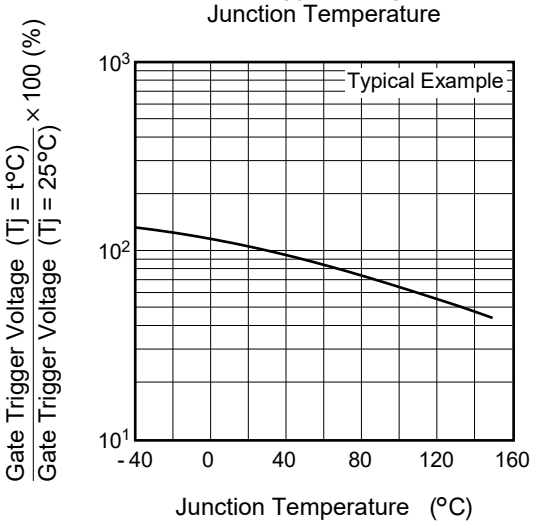
Gate Characteristics (I, II and III)



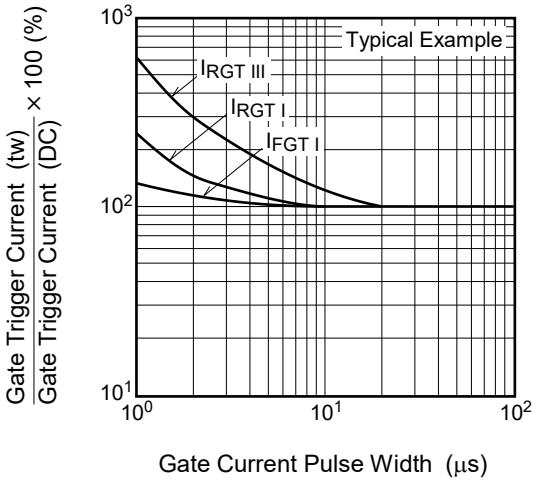
Gate Trigger Current vs. Junction Temperature



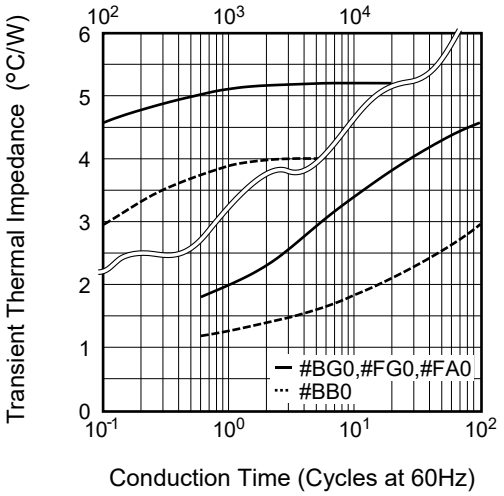
Gate Trigger Voltage vs. Junction Temperature



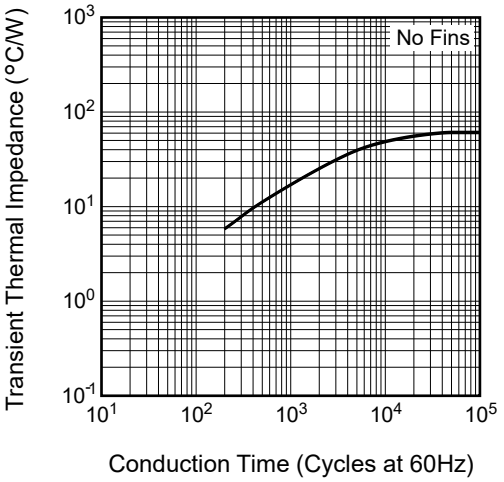
Gate Trigger Current vs. Gate Current Pulse Width



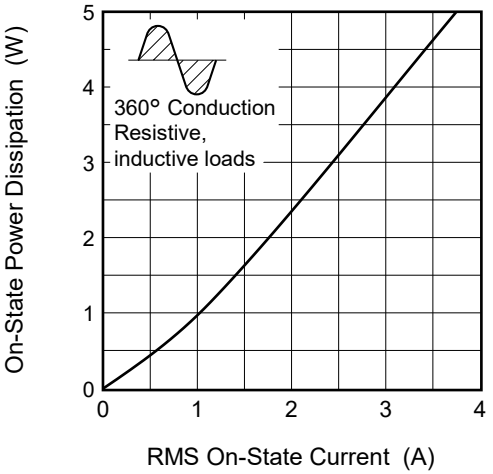
Maximum Transient Thermal Impedance Characteristics (Junction to case)



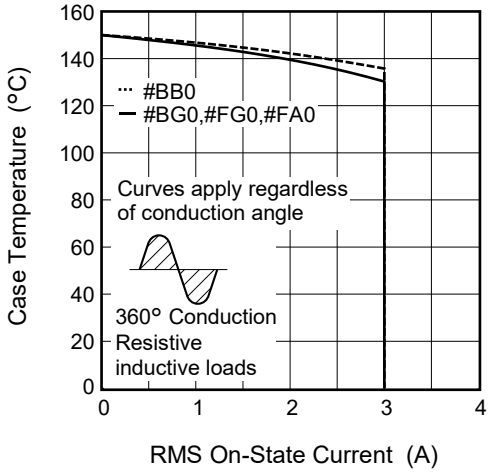
Maximum Transient Thermal Impedance Characteristics (Junction to ambient)



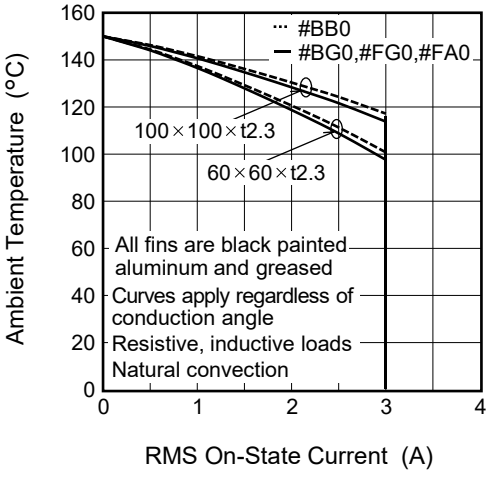
Maximum On-State Power Dissipation



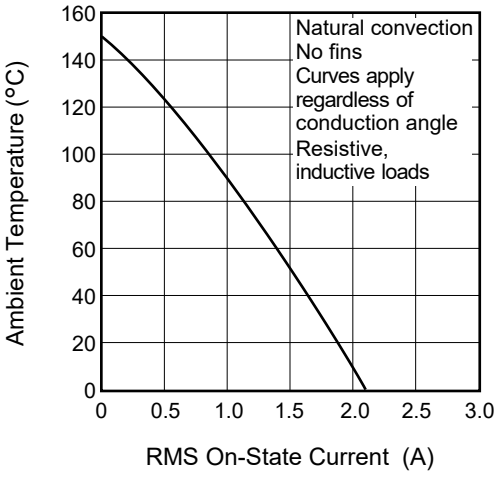
Allowable Case Temperature vs. RMS On-State Current



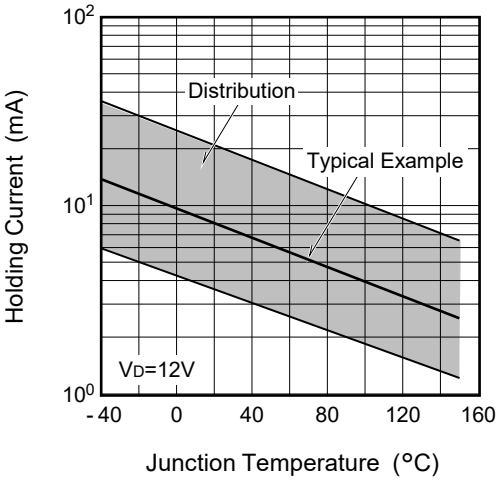
Allowable Ambient Temperature vs. RMS On-State Current



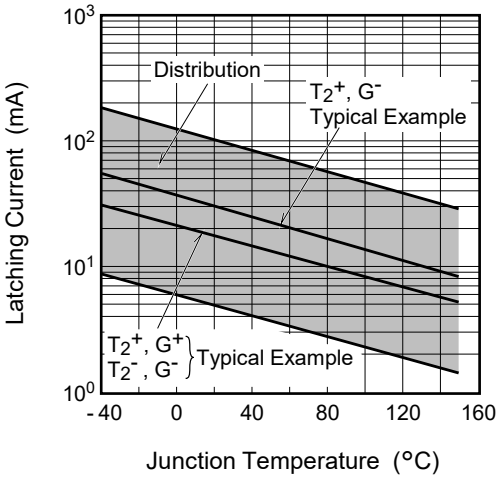
Allowable Ambient Temperature vs. RMS On-State Current



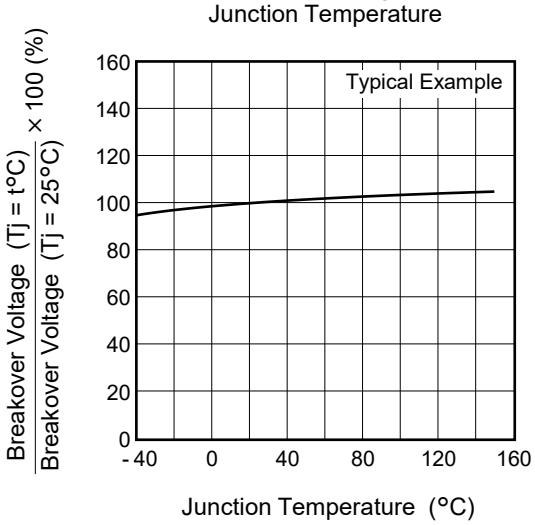
Holding Current vs.
Junction Temperature



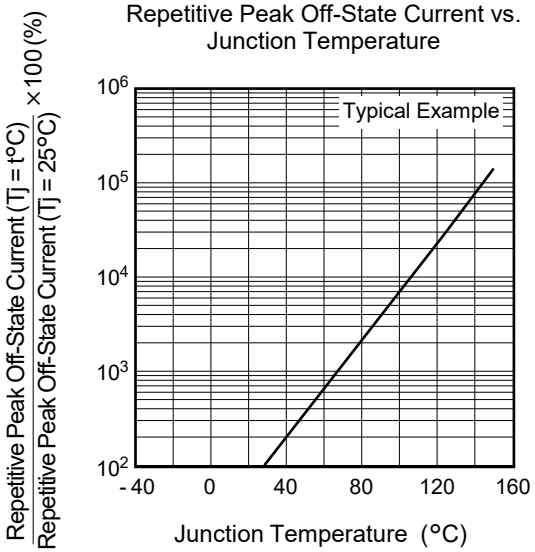
Latching Current vs.
Junction Temperature



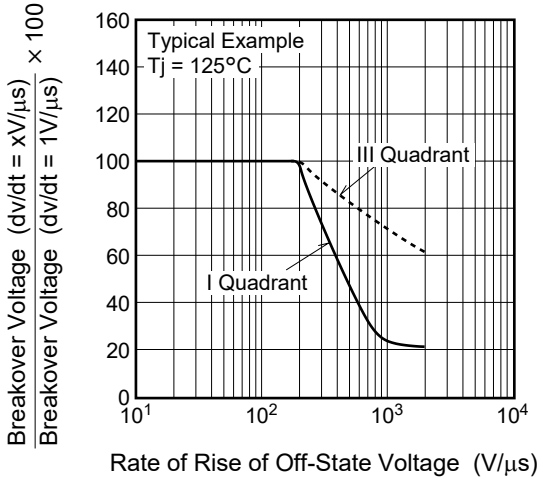
Breakover Voltage vs.
Junction Temperature



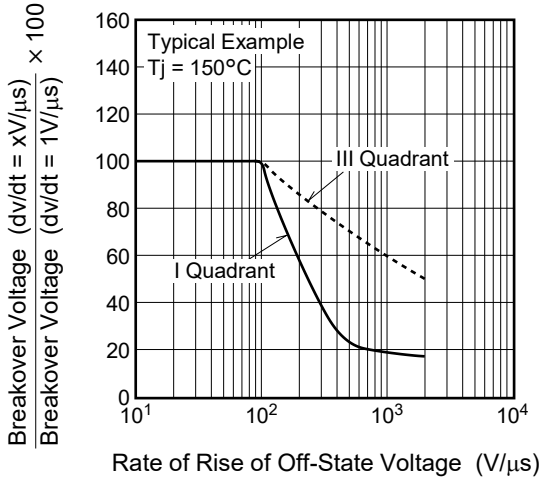
Repetitive Peak Off-State Current vs.
Junction Temperature



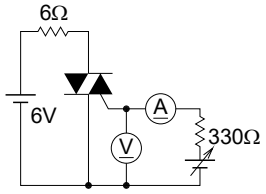
Breakover Voltage vs.
Rate of Rise of Off-State Voltage (Tj=125°C)



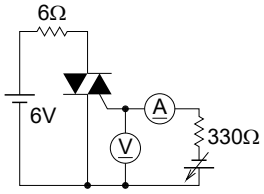
Breakover Voltage vs.
Rate of Rise of Off-State Voltage (Tj=150°C)



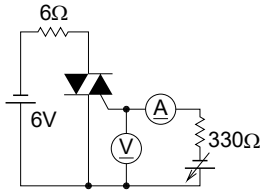
Gate Trigger Characteristics Test Circuits



Test Procedure I

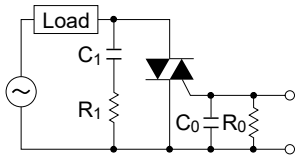


Test Procedure II



Test Procedure III

Recommended peripheral components for Triac



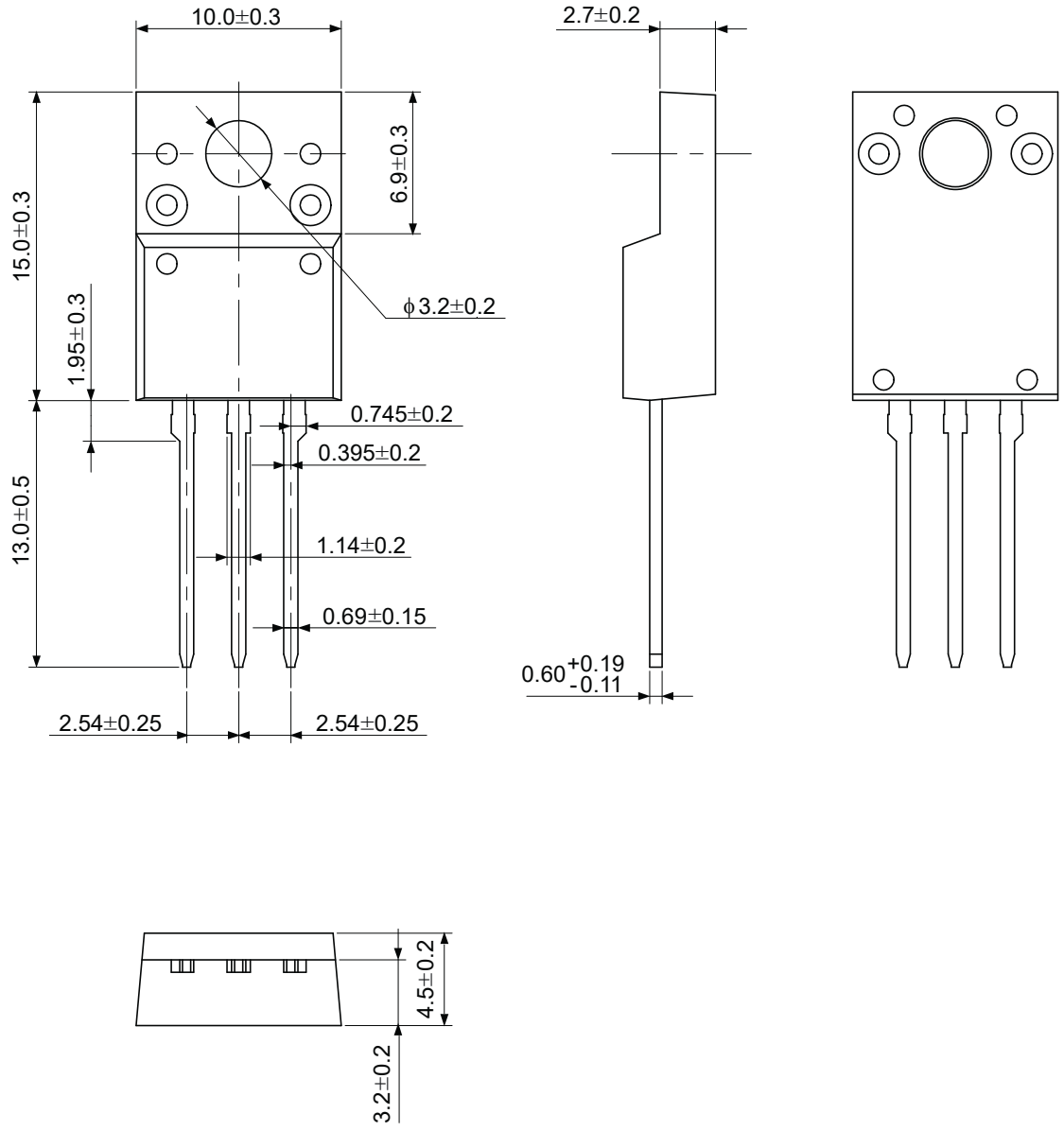
C_1 = 0.1 to 0.47 μF C_0 = 0.1 μF
R_1 = 47 to 100Ω R_0 = 100Ω

Package Dimensions

Ordering code: #BG0, #FG0

JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]
-	PRSS0003AP-A	TO-220FPA	1.65

Unit: mm

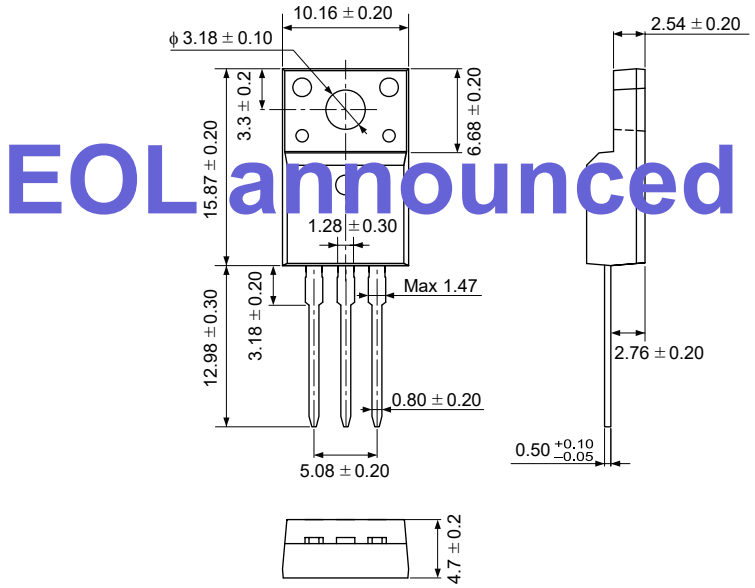


Package Dimensions

Ordering code: #BB0, #FA0 <EOL announced>

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
TO-220FP		PRSS0003AG-A		1.9g

Unit: mm



Ordering Information

Orderable Part Number	Package	Quantity Note7	Remark	Quality Grade Note9
BCR3FM-12RB#BG0	TO-220FPA	50 pcs./ tube	Straight type	General Industrial & General Consumer Use
BCR3FM-12RB-1#BG0	TO-220FPA	50 pcs./ tube	Straight type, I_{GT} item:1	
BCR3FM-12RB-□□#BG0	TO-220FPA	50 pcs./ tube	□□:Lead form type	
BCR3FM-12RB1□□#BG0	TO-220FPA	50 pcs./ tube	□□:Lead form type, I_{GT} item:1	
BCR3FM-12RB#BB0	TO-220FP	50 pcs./ tube	Straight type	EOL announced
BCR3FM-12RB#FG0	TO-220FPA	50 pcs./ tube	Straight type	Special Consumer Use Note8
BCR3FM-12RB-□□#FG0	TO-220FPA	50 pcs./ tube	□□:Lead form type	
BCR3FM-12RB#FA0	TO-220FP	50 pcs./ tube	Straight type	EOL announced

Notes: 7. Please confirm the specification about the shipping in detail.

8. “Special Consumer Use” grade product is not tested for the “Temperature Humidity Bias” reliability in the condition of rated V_{DRM}. Please be sure to implement qualification tests and judge whether the product meets your criteria. If necessary, please apply moisture-proof measures according to user’s conditions.
9. For further details about the classification in the Standard quality grade, please refer to the application note.

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RENESAS

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